

SURFACE MOUNT FAST SWITCHING DIODE

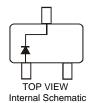
Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- "Green" Device (Notes 4 and 5)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe)
- BAS19W Marking: KA8 or KT2 or KT3 (See Page 2)
- BAS20W Marking: KT2 or KT3 (See Page 2)
- BAS21W Marking: KT3 (See Page 2)
- Weight: 0.006 grams (approximate)

SOT-323



TOP VIEW

Maximum Ratings $@T_A = 25\%$ unless otherwise specified

Characteristic		Symbol	BAS19W	BAS21W	Unit	
Repetitive Peak Reverse Voltage			120	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage			100 150		200	V
RMS Reverse Voltage	V _{R(RMS)}	71	106	141	V	
Forward Continuous Current (Note 1)				400		
Average Rectified Output Current (Note 1)				mA		
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0s			2.5 0.5			А
Repetitive Peak Forward Surge Current				mA		

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	€/M
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

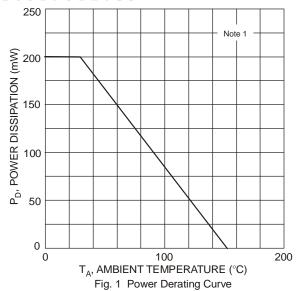
Electrical Characteristics @TA = 25°C unless otherwise specified

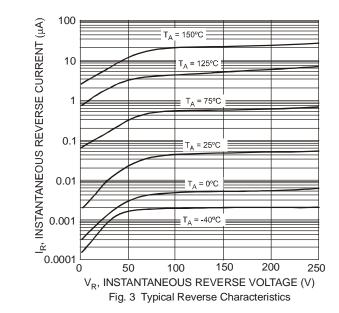
Characteristic	Symbol	Min	Max	Unit	Test Condition	
Reverse Breakdown Voltage (Note 2)	BAS19W BAS20W BAS21W	V _{(BR)R}	120 200 250		٧	Ι _R = 100μΑ
Forward Voltage		VF	_	1.0 1.25	V	I _F = 100mA I _F = 200mA
Reverse Current @ Rated DC Blocking Voltage (Note 2)		I _R	_	100 15	nA μA	T _J = 25°C T _J = 100°C
Total Capacitance		CT	_	5.0	pF	$V_R = 0$, $f = 1.0MHz$
Reverse Recovery Time		t _{rr}	_	50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

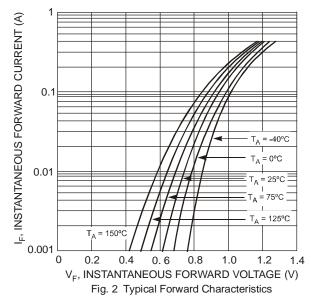
Notes:

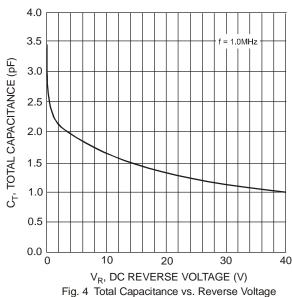
- Part mounted on FR-4 PC board with minimum recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. Short duration pulse test used to minimize self-heating effect.
- 3. No purposefully added lead.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 5. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.









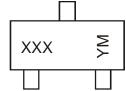


Ordering Information (Notes 5 & 6)

Part Number	Case	Packaging
BAS19W-7-F	SOT-323	3000/Tape & Reel
BAS20W-7-F	SOT-323	3000/Tape & Reel
BAS21W-7-F	SOT-323	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



XXX = Product Type Marking Code (See Page 1) YM = Date Code Marking Y = Year ex: N = 2002

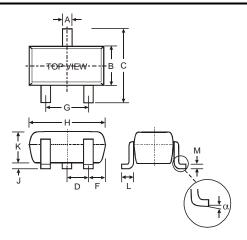
M = Month ex: 9 = September

Date Code Key

Date Code Key													
Year	2000	2001	2002	2003	2004	2005	2006	200	7 2008	2009	2010	2011	2012
Code	L	М	N	Р	R	S	T	U	V	W	Х	Υ	Z
Month	Jan	Feb	Mar	Apr	Ма	ıy J	un	Jul	Aug	Sep	Oct	Nov	Dec
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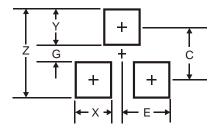


Package Outline Dimensions



SOT-323					
Dim	Min	Max			
Α	0.25	0.40			
В	1.15 1.35				
С	2.00 2.20				
D	0.65 N	ominal			
F	0.30 0.40				
G	1.20 1.40				
Н	1.80 2.20				
J	0.0 0.10				
K	0.90 1.00				
L	0.25 0.40				
M	0.10	0.18			
α	0°	8°			
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.8
G	1.0
X	0.7
Y	0.9
С	1.9
E	0.65

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